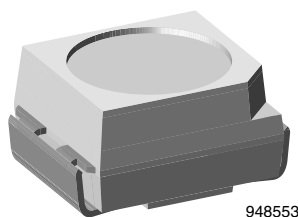


Standard SMD LED PLCC-2



DESCRIPTION

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the VLMG31-series is the PLCC-2.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-2
- Product series: standard
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- SMD LEDs with exceptional brightness
- Luminous intensity categorized
- EIA and ICE standard package
- Available in 8 mm tape
- Low power consumption
- Low profile package
- Compatible with IR reflow, vapor phase and wave solder processes according to CECC 00802 and J-STD-020
- Compatible with automatic placement equipment
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leq 1.6$
- Preconditioning according to JEDEC® level 2a
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols
- General use

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I _F (mA)	WAVELENGTH (nm)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMG31K1L2-GS08	Green	7.1	15	18	10	562	572	575	10	-	2.1	2.8	20	GaP on GaP
VLMG31K1L2-GS18	Green	7.1	15	18	10	562	572	575	10	-	2.1	2.8	20	GaP on GaP
VLMG31K1M2-GS08	Green	7.1	15	28	10	562	572	575	10	-	2.1	2.8	20	GaP on GaP
VLMG31L1M2-GS08	Green	11.2	16	28	10	562	572	575	10	-	2.1	2.8	20	GaP on GaP
VLMG31L1M2-GS18	Green	11.2	16	28	10	562	572	575	10	-	2.1	2.8	20	GaP on GaP

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

VLMG31..

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V_R	6	V
DC forward current	$T_{amb} \leq 74\text{ }^{\circ}\text{C}$	I_F	20	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	0.34	A
Power dissipation		P_V	56	mW
Junction temperature		T_j	100	$^{\circ}\text{C}$
Operating temperature range		T_{amb}	-40 to +100	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +100	$^{\circ}\text{C}$
Soldering temperature	$t \leq 5\text{ s}$	T_{sd}	260	$^{\circ}\text{C}$
Thermal resistance junction to ambient	Mounted on PC board (pad size > 16 mm ²)	R_{thJA}	400	K/W

Note

⁽¹⁾ Driving LED in reverse direction is suitable for short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

VLMG31.., GREEN

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 10\text{ mA}$	VLMG31K1L2	I_V	7.1	15	18	mcd
		VLMG31K1M2	I_V	7.1	15	28	mcd
		VLMG31L1M2	I_V	11.2	16	28	mcd
Dominant wavelength	$I_F = 10\text{ mA}$		λ_d	562	572	575	nm
Peak wavelength	$I_F = 10\text{ mA}$		λ_p	-	565	-	nm
Angle of half intensity	$I_F = 10\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 20\text{ mA}$		V_F	-	2.1	2.8	V
Reverse current	$V_R = 6\text{ V}$		I_R	-	0.01	10	μA
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin.} \leq 1.6$

LUMINOUS INTENSITY CLASSIFICATION

GROUP	LIGHT INTENSITY (mcd)		
	STANDARD	OPTIONAL	MIN. MAX.
K	1	7.1	9
	2	9	11.2
L	1	11.2	14.0
	2	14.0	18.0
M	1	18.0	22.4
	2	22.4	28.0

Note

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$.
The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.
In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.
In order to ensure availability, single wavelength groups will not be orderable

COLOR CLASSIFICATION

GROUP	GREEN	
	DOM. WAVELENGTH (nm)	
	MIN.	MAX.
3	562	565
4	564	567
5	566	569
6	568	571
7	570	573
8	572	575

Note

- Wavelengths are tested at a current pulse duration of 25 ms

CROSSING TABLE

VISHAY	OSRAM
VLMG31K1L2	LGT670-K1L2
VLMG31K1M2	LGT670-K1M2
VLMG31L1M2	LGT670-L1M2

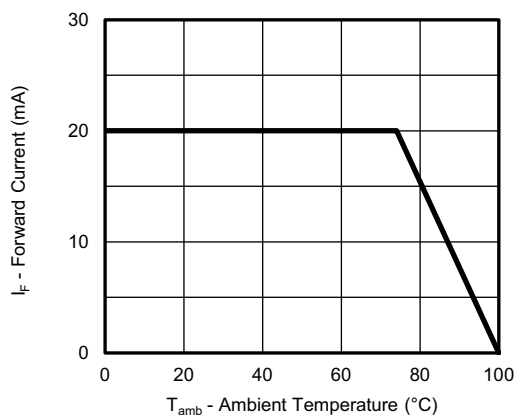
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature

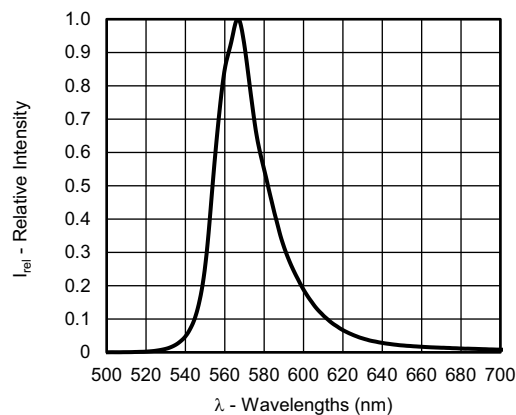


Fig. 4 - Relative Intensity vs. Wavelength

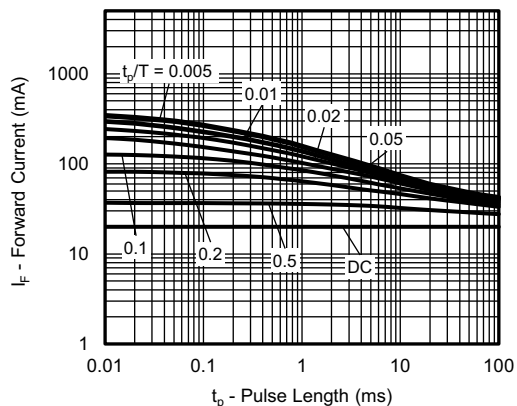


Fig. 2 - Pulse Forward Current vs. Pulse Duration

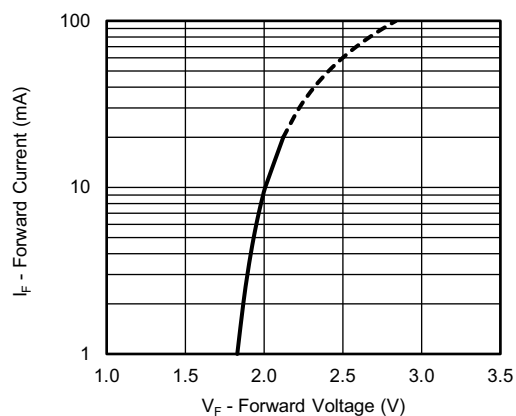


Fig. 5 - Forward Current vs. Forward Voltage

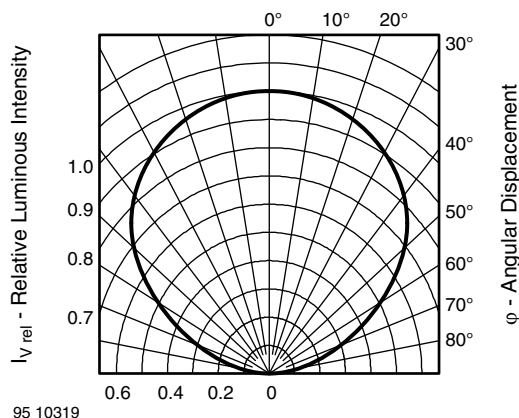


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

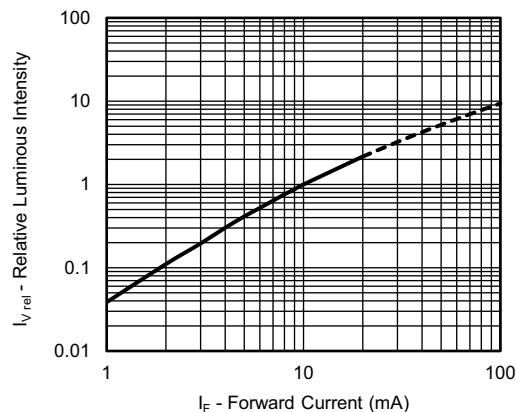


Fig. 6 - Relative Luminous Intensity vs. Forward Current

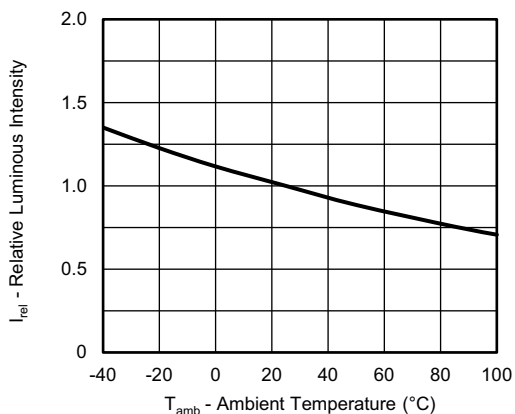


Fig. 7 - Relative Luminous Intensity vs. Ambient Temperature

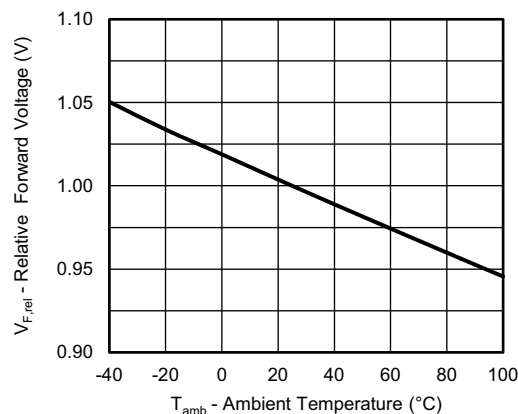
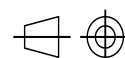
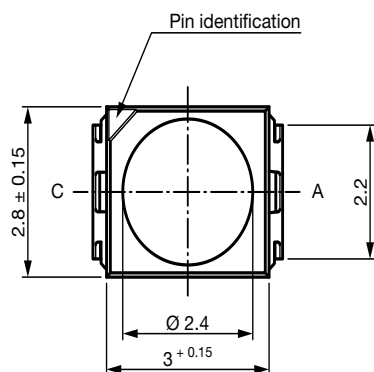
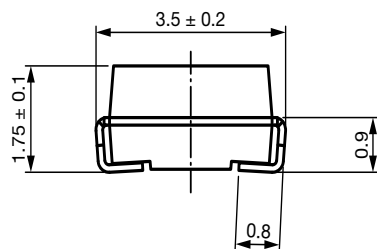


Fig. 8 - Relative Forward Voltage vs. Ambient Temperature

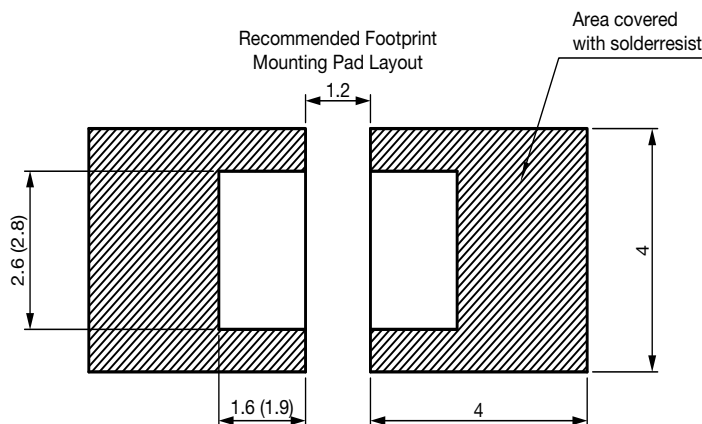
PACKAGE DIMENSIONS in millimeters



technical drawings
according to DIN
specifications

Drawing-No.: 6.541-5067.01-4

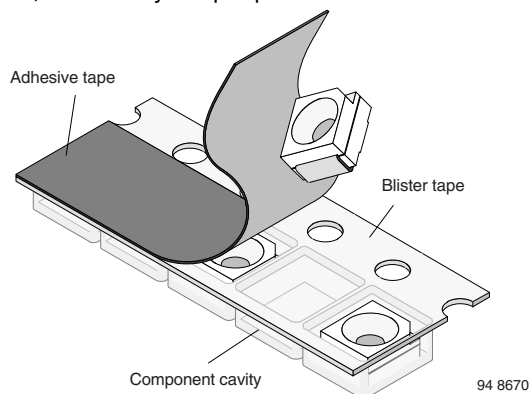
Issue: 7; 12.03.14



METHOD OF TAPING / POLARITY AND TAPE AND REEL

SMD LED (VLM3-SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

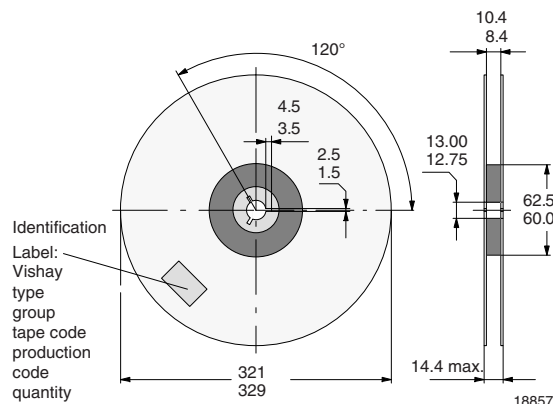


Fig. 11 - Reel Dimensions - GS18

TAPING OF VLM.3..

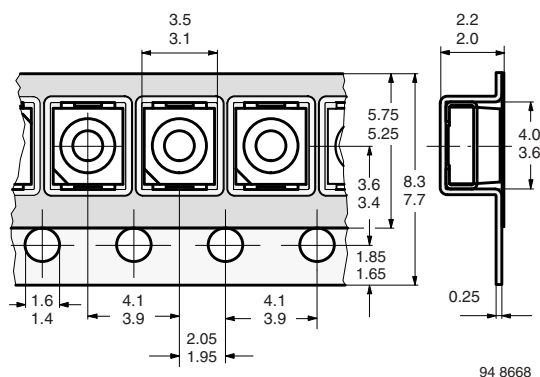


Fig. 9 - Tape Dimensions in mm for PLCC-2

REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

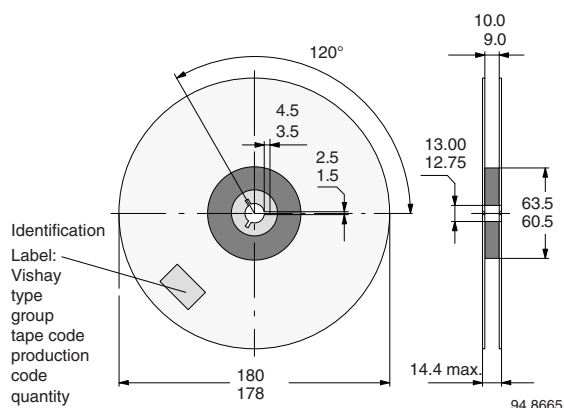


Fig. 10 - Reel Dimensions - GS08

SOLDERING PROFILE

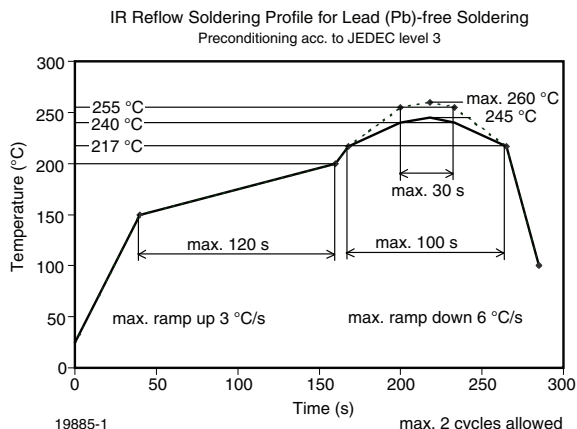


Fig. 12 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020)

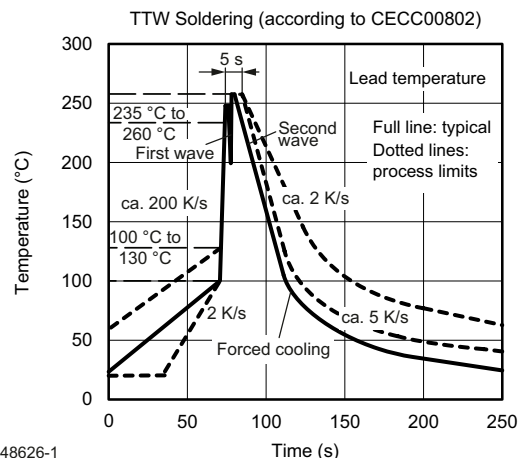
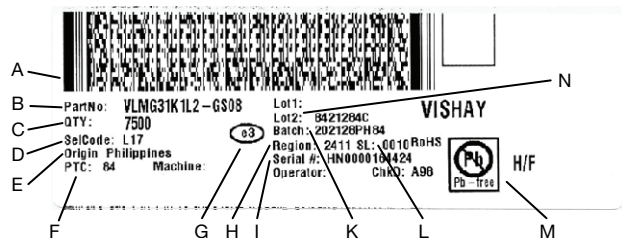


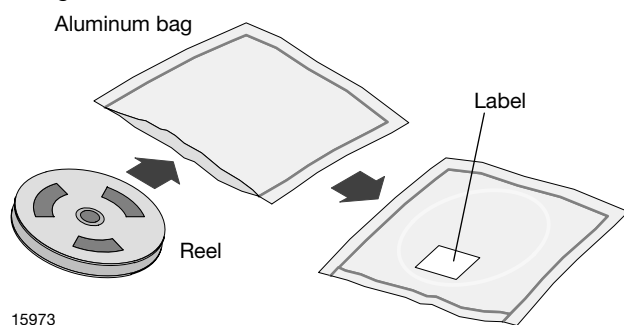
Fig. 13 - Double Wave Soldering of Opto Devices (all Packages)

BAR CODE PRODUCT LABEL (example)


- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: production plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch Number: year, week, country code, plant code
- L. SL: storage location
- M. Environmental Symbols: RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.


FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.

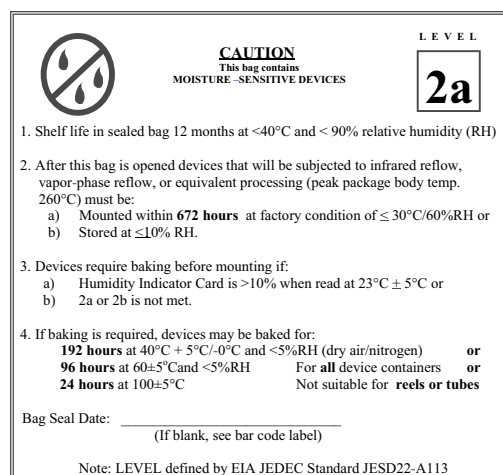


Fig. 14 - Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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